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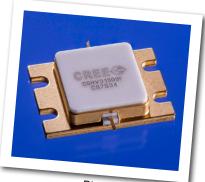
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CGHV31500F 500 W, 2700 - 3100 MHz, 50-Ohm Input/Output Matched, GaN HEMT for S-Band Radar Systems

Cree's CGHV31500F is a gallium nitride (GaN) high electron mobility transistor (HEMT) designed specifically with high efficiency, high gain and wide bandwidth capabilities, which makes the CGHV31500F ideal for 2.7 - 3.1 GHz S-Band radar amplifier applications. The transistor is supplied in a ceramic/metal flange package, type 440217.



PN: CGHV31500F Package Type: 440217

Typical Performance Over 2.7-3.1 GHz (T_c = 25°C) of Demonstration Amplifier

Parameter	2.7 GHz	2.9 GHz	3.1 GHz	Units
Output Power	650	705	605	w
Gain	12.1	12.5	11.8	dB
Drain Efficiency	70	68	58	%

Note:

Measured in the CGHV31500F-AMP application circuit, under 100 μ s pulse width, 10% duty cycle, P_{IN} = 46 dBm.

Features

- 2.7 3.1 GHz Operation
- 650 W Typical Output Power
- 12 dB Power Gain
- 65% Typical Drain Efficiency
- 50 Ohm Internally Matched
- <0.3 dB Pulsed Amplitude Droop

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Absolute Maximum Ratings (not simultaneous)

Parameter	Symbol	Rating	Units	Conditions
Pulse Width	PW	100	μs	
Duty Cycle	DC	10	%	
Drain-Source Voltage	V _{DSS}	125	Volts	25°C
Gate-to-Source Voltage	V _{GS}	-10, +2	Volts	25°C
Storage Temperature	T _{stg}	-65, +150	°C	
Operating Junction Temperature	TJ	225	°C	
Maximum Forward Gate Current	I _{GMAX}	80	mA	25°C
Maximum Drain Current ¹	I _{DMAX}	24	А	25°C
Soldering Temperature ²	Τ _s	245	°C	
Screw Torque	τ	40	in-oz	
Pulsed Thermal Resistance, Junction to Case	$R_{_{ ext{ ext{ ext{ heta}}JC}}}$	0.22	°C/W	100 μsec, 10%, 85°C , P _{DISS} = 376 W
Case Operating Temperature	T _c	-40, +125	°C	

Notes:

¹ Current limit for long term, reliable operation

² Refer to the Application Note on soldering at http://www.cree.com/rf/document-library

Electrical Characteristics

Characteristics	Symbol	Min.	Тур.	Max.	Units	Conditions
DC Characteristics ¹ (T _c = 25°C)						
Gate Threshold Voltage	$V_{\rm GS(th)}$	-3.8	-3.0	-2.3	V _{DC}	V _{DS} = 10 V, I _D = 83.6 mA
Gate Quiescent Voltage	$V_{GS(Q)}$	-	-2.7	-	V _{DC}	V _{DS} = 50 V, I _D = 0.5 A
Saturated Drain Current ²	I _{DS}	62.7	75.5	-	А	$V_{_{DS}}$ = 6.0 V, $V_{_{GS}}$ = 2.0 V
Drain-Source Breakdown Voltage	V _{BR}	150	-	-	V _{DC}	V_{gs} = -8 V, I _D = 83.6 mA

Notes:

¹ Measured on wafer prior to packaging.

² Scaled from PCM data.

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Electrical Characteristics Continued...

Characteristics	Symbol	Min.	Тур.	Max.	Units	Conditions	
RF Characteristics ³ (T _c = 25°C, F ₀ = 2.7 - 3.1 GHz unless otherwise noted)							
Output Power at 2.7 GHz	P _{OUT1}	-	650	-	W	$V_{_{DD}}$ = 50 V, $I_{_{DQ}}$ = 500 mA, $P_{_{IN}}$ = 46 dBm	
Output Power at 2.9 GHz	P _{OUT2}	-	705	-	W	$V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Output Power at 3.1 GHz	P _{out3}	-	605	-	W	$V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Gain at 2.7 GHz	G _{P1}	-	12.1	-	dB	$V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Gain at 2.9 GHz	G _{P2}	-	12.5	-	dB	$V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Gain at 3.1 GHz	G _{P3}	-	11.8	-	dB	$V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Drain Efficiency at 2.7 GHz	D _{E1}	-	70	-	%	$V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Drain Efficiency at 2.9 GHz	D _{E2}	-	68	-	%	$V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Drain Efficiency at 3.1 GHz	D _{E3}	-	58	-	%	$V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Small Signal Gain	S21	-	14.5	-	dB	$V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Input Return Loss	S11	-	-15	-	dB	$V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Output Return Loss	S22	-	-5	-	dB	$V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Amplitude Droop	D	-	-0.3	-	dB	$V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Output Stress Match	VSWR	-	5:1	-	Ψ	No damage at all phase angles, $V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 500 mA, $P_{_{IN}}$ = 46 dBm Pulsed	

Notes:

 $^{\rm 3}$ Measured in CGHV31500F-AMP. Pulse Width = 100 $\mu S,$ Duty Cycle = 10%.

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Typical Performance

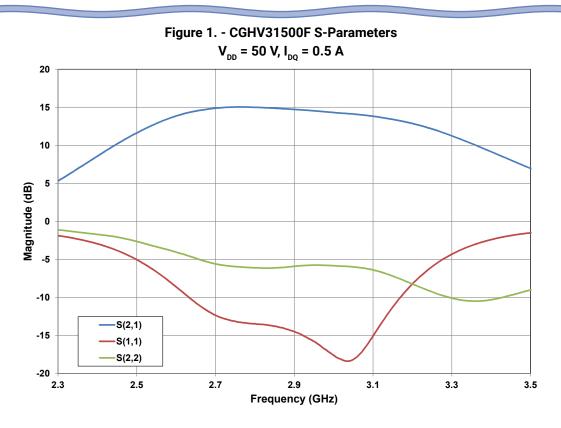
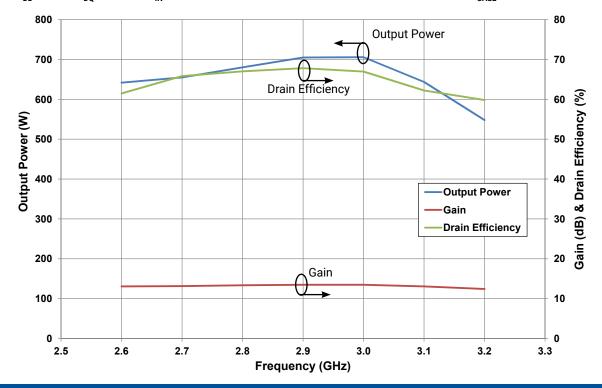


Figure 2. - CGHV31500F Output Power and Drain Efficiency vs Frequency V_{DD} = 50 V, I_{DQ} = 0.5 A, P_{IN} = 46 dBm, Pulse Width = 100µs, Duty Cycle = 10%, T_{CASE} = 25°C

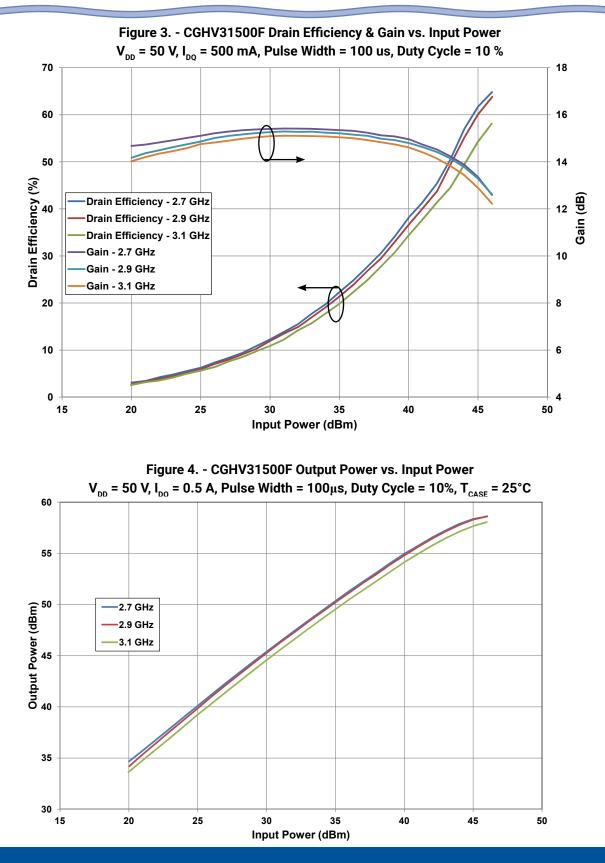


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Typical Performance



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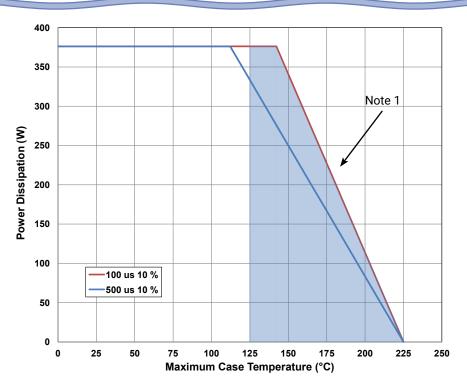
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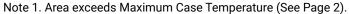


CGHV31500F-AMP Application Circuit Bill of Materials

Designator	Description	Qty
R1	RES, 511, OHM, +/- 1%, 1/16W, 0603	1
R2	RES, 5.1, OHM, +/- 1%, 1/16W, 0603	1
C1	CAP, 6.8pF, +/-0.25%, 250V, 0603	1
C2, C7, C8	CAP, 10.0pF, +/-1%, 250V, 0805	3
C3	CAP, 10.0pF, +/-5%, 250V, 0603	1
C4, C9	CAP, 470pF, 5%, 100V, 0603, X	2
C5	CAP, 33000 pF, 0805, 100V, X7R	1
C6	CAP, 10uF 16V TANTALUM	1
C10	CAP, 1.0uF, 100V, 10%, X7R, 1210	1
C11	CAP, 33uF, 20%, G CASE	1
C12	CAP, 3300uF, +/-20%, 100V, ELECTROLYTIC	1
J1,J2	CONN, SMA, PANEL MOUNT JACK, FL	2
J3	HEADER, RT>PLZ, 0.1CEN LK 9POS	1
J4	CONNECTOR; SMB, Straight, JACK, SMD	1
W1	CABLE, 18 AWG, 4.2	1
-	PCB, RO4350, 2.5 X 4.0 X 0.030	1
Q1	CGHV31500F	1

CGHV31500F Power Dissipation De-rating Curve





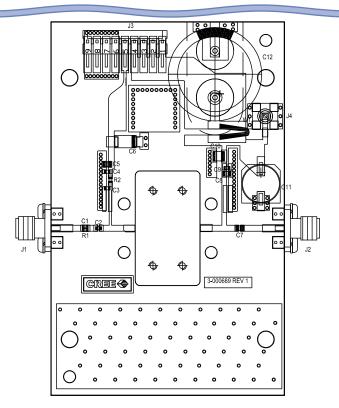
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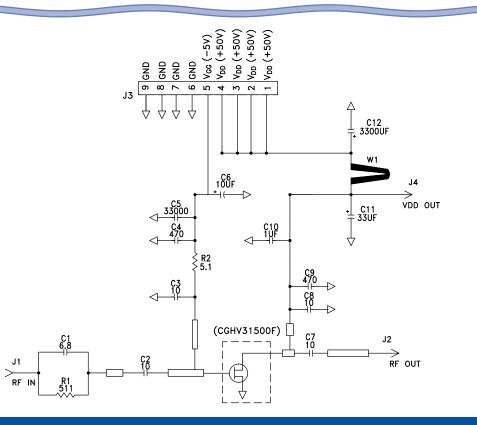
CGHV31500F Rev 2.1



CGHV31500F-AMP Application Circuit Outline



CGHV31500F-AMP Application Circuit Schematic



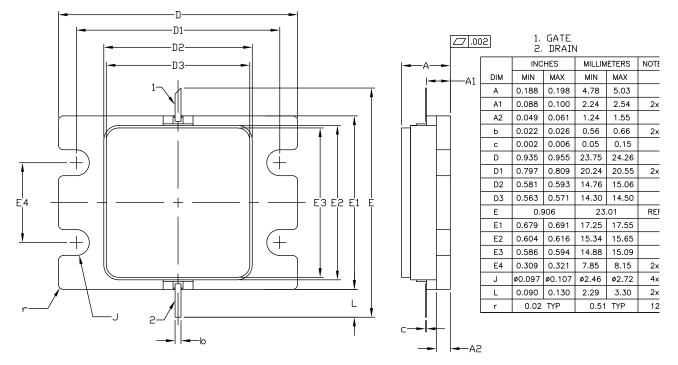
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Product Dimensions CGHV31500F (Package Type - 440217)



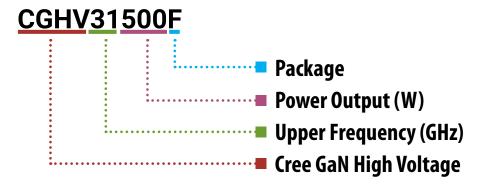


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Part Number System



Parameter	Value	Units
Upper Frequency ¹	3.1	GHz
Power Output	500	W
Package	Flange	-

Table 1.

Note¹: Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Character Code	Code Value
А	0
В	1
С	2
D	3
E	4
F	5
G	6
Н	7
J	8
К	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz

Table 2.

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Product Ordering Information

Order Number	Description	Unit of Measure	Image
CGHV31500F	GaN HEMT	Each	Conversion of the second
CGHV31500F-TB	Test board without GaN HEMT	Each	
CGHV31500F-AMP	Test board with GaN HEMT installed	Each	

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